# **S5AH – S5MH**

Taiwan Semiconductor

# 5A, 50V - 1000V Surface Mount Rectifier

#### **FEATURES**

• AEC-Q101 gualified

TAIWAN

• Glass passivated chip junction

EMICONDUCTOR

- Ideal for automated placement
- Low forward voltage drop
- High current capability
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- DC to DC converter
- Automotive application
- Car lighting
- Snubber
- General purpose

#### **MECHANICAL DATA**

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.210g (approximately)

KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
I <sub>F</sub>	5	А		
V <sub>RRM</sub>	50 - 1000	V		
I <sub>FSM</sub>	100	А		
T <sub>J MAX</sub>	150	°C		
Package DO-214AB (SMC)				
Configuration	Single die			
Ph DOLS HALOGEN				



KOH2

DO-214AB (SMC)



ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)									
PARAMETER	SYMBOL	S5 AH	S5 BH	S5 DH	S5 GH	S5 JH	S5 KH	S5 Mh	UNIT
Marking code on the device		S5A	S5B	S5D	S5G	S5J	S5K	S5M	
Repetitive peak reverse voltage	V <sub>RRM</sub>	50	100	200	400	600	800	1000	V
Reverse voltage, total rms value	V <sub>R(RMS)</sub>	35	70	140	280	420	560	700	V
Forward current	I <sub>F</sub>				5				Α
Peak forward surge current, 8.3ms single half sine wave superimposed on rated load	I <sub>FSM</sub>	100				A			
Junction temperature	TJ	- 55 to +150			°C				
Storage temperature	T <sub>STG</sub>	<sub>G</sub> - 55 to +150			°C				





THERMAL PERFORMANCE				
PARAMETER	SYMBOL	ТҮР	UNIT	
Junction-to-lead thermal resistance	R <sub>θJL</sub>	13	°C/W	
Junction-to-ambient thermal resistance	R <sub>eja</sub>	47	°C/W	

<b>ELECTRICAL SPECIFICATIONS</b> ( $T_A = 25^{\circ}C$ unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage <sup>(1)</sup>	I <sub>F</sub> = 5A, T <sub>J</sub> = 25°C	V <sub>F</sub>	-	1.15	V
Reverse current @ rated $V_R^{(2)}$	T <sub>J</sub> = 25°C	- I <sub>R</sub>	-	10	μA
	T <sub>J</sub> = 125°C		-	250	μA
Junction capacitance	1MHz, V <sub>R</sub> = 4.0V	CJ	60	-	pF
Reverse recovery time	$I_F = 0.5A, I_R = 1.0A, I_{rr} = 0.25A$	t <sub>rr</sub>	1500	-	ns

#### Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING		
S5xH	DO-214AB (SMC)	3,000 / Tape & Reel		

Notes:

1. "x" defines voltage from 50V(S5AH) to 1000V(S5MH)



#### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

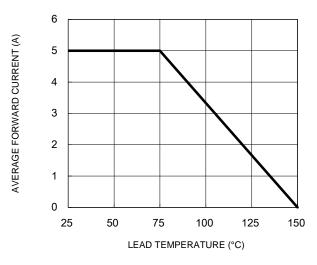
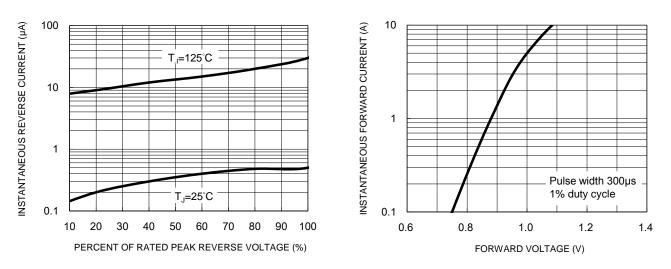


Fig.1 Forward Current Derating Curve

**Fig.3 Typical Reverse Characteristics** 



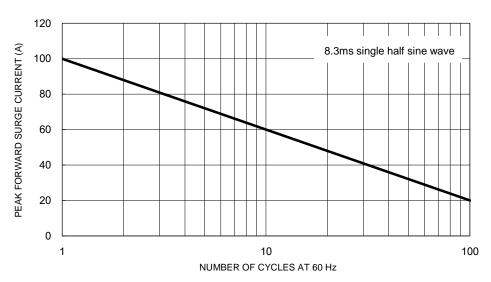
100

10

1

f=1.0MHz Vsig=50mVp-p

CAPACITANCE (pF)



#### Fig.5 Maximum Non-Repetitive Forward Surge Current

100

**Fig.2 Typical Junction Capacitance** 

10

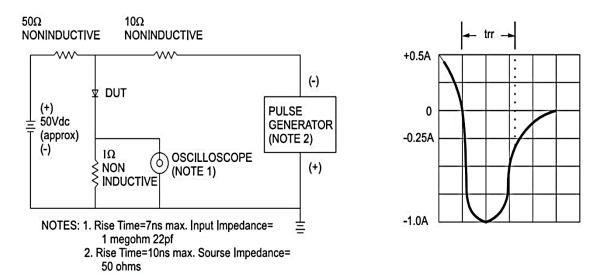
REVERSE VOLTAGE (V)

**Fig.4 Typical Forward Characteristics** 



#### **CHARACTERISTICS CURVES**

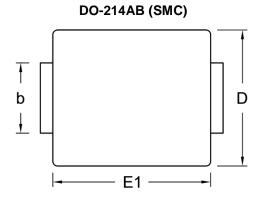
 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

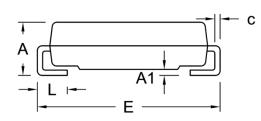


#### Fig.6 Reverse Recovery Time Characteristic and Test Circuit Diagram



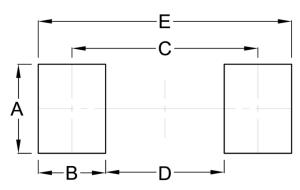
## PACKAGE OUTLINE DIMENSIONS





DIM.	Unit (mm)		Unit (	(inch)
	Min.	Max.	Min.	Max.
A	2.00	2.62	0.079	0.103
A1	0.10	0.20	0.004	0.008
b	2.90	3.20	0.114	0.126
с	0.15	0.31	0.006	0.012
D	5.59	6.22	0.220	0.245
E	7.75	8.13	0.305	0.320
E1	6.60	7.11	0.260	0.280
L	1.00	1.60	0.039	0.063

## SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	3.30	0.130
В	2.50	0.098
С	6.90	0.272
D	4.40	0.173
E	9.40	0.370

## **MARKING DIAGRAM**



- P/N = Marking Code
- G = Green Compound

YW = Date Code

F = Factory Code



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